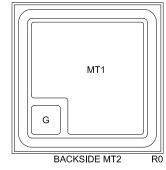


CPQ114-CQD-8M3 Three Quadrant TRIAC Die 8.0 Amp, 600 Volt

The CPQ114-CQD-8M3 is a silicon TRIAC designed for full wave AC control applications featuring gate triggering in three quadrants.



		Die Size	114 x 114 MILS
		Die Thickness	8.3 MILS
1		Gate Bonding Pad Size	21.7 x 21.7 MILS
		MT1 Bonding Pad Size	84.6 x 84.6 MILS
		Top Side Metalization	AI – 45,000Å
		Back Side Metalization	Al/Ti/Ni/Ag – 36,600Å
		Scribe Alley Width	3.0 MILS
		Wafer Diameter	4 INCHES
20)	Gross Die Per Wafer	787

MECHANICAL SPECIFICATIONS:

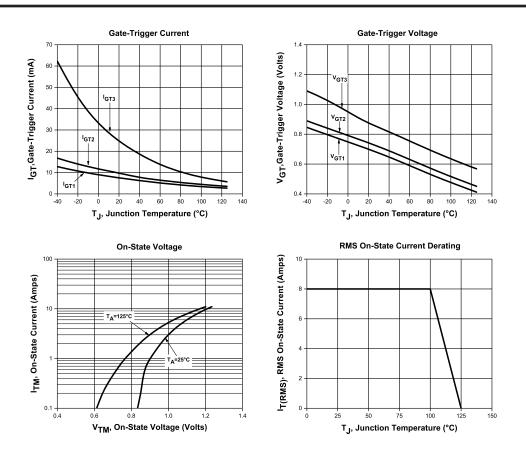
MAXIMUM RATINGS: (TJ=25°C unless otherwise noted)

		SYMBOL		UNITS
Peak F	Repetitive Off-State Voltage	VDRM	600	V
RMS C	on-State Current (T _J =100°C)	^I T(RMS)	8.0	А
Peak C	One Cycle Surge Current, 50Hz	ITSM	70	А
l²t Valu	e for Fusing, t=10ms	l²t	32	A ² s
Peak C	Gate Current, tp=20µs (T _J =125°C)	IGM	4.0	А
Critical	Rate of Rise of On-State Current			
Repeti	tive, f=100Hz (T _J =125°C)	di/dt	50	A/µs
Operat	ing Junction Temperature	Тј	-40 to +125	°C
Storag	e Temperature	T _{stg}	-40 to +150	°C
-		6		
ELEC1	RICAL CHARACTERISTICS: (T	-	ed)	
SYMB	OL TEST CONDITIONS	-	ed) MAX	UNITS
SYMB		J=25°C unless otherwise not	,	<mark>UNITS</mark> μA
SYMB	OL TEST CONDITIONS	J=25°C unless otherwise not MIN	MAX	
SYMB I _{DRM} ,	DL TEST CONDITIONS	J=25°C unless otherwise not MIN	MAX 5.0	μA
SYMB I _{DRM} , I _{GT}	OL TEST CONDITIONS I _{RRM} V _{DRM} , V _{RRM} =600V V _D =12V, R _L =30Ω, QUAD	J=25°C unless otherwise not MIN	MAX 5.0 50	μA mA
SYMB(I _{DRM} , I _{GT} I _H	OL TEST CONDITIONS I _{RRM} V_{DRM} , V_{RRM} =600V V_{D} =12V, R_{L} =30Ω, QUAE V_{D} =12V, I_{T} =100mA	J=25°C unless otherwise not MIN	MAX 5.0 50 50	μA mA mA
SYMB I _{DRM} , I _{GT} I _H V _{GT}	DL TEST CONDITIONS I_{RRM} V_{DRM} , V_{RRM} =600V V_{D} =12V, R_{L} =30 Ω , QUAE V_{D} =12V, I_{T} =100mA V_{D} =12V, R_{L} =30 Ω , QUAE	J=25°C unless otherwise not MIN	MAX 5.0 50 50 1.3	μA mA mA V

R0 (13-February 2017)

CPQ114-CQD-8M3 Typical Electrical Characteristics

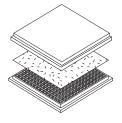




R0 (13-February 2017)

BARE DIE PACKING OPTIONS



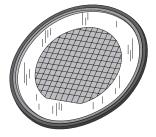


BARE DIE IN TRAY (WAFFLE) PACK

- CT: Singulated die in tray (waffle) pack. (example: CP211-PART NUMBER-CT)
- CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-<u>PART NUMBER</u>-CM)

UNSAWN WAFER

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



SAWN WAFER ON PLASTIC RING

WR: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked. (example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- · Environmental regulation compliance
- Customer specific screening
- · Up-screening capabilities

· Custom product packing

Custom bar coding for shipments

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when 1. ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

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